

## N-Channel Enhancement Mode MOSPOWER

### APPLICATIONS

- Switching Regulators
- Converters
- Motor Drivers

### PRODUCT SUMMARY

Part Number	$BV_{DSS}$ Volts	$r_{DS(ON)}$ (ohms)
2N6661	90	4

PIN 1 - Source  
 PIN 2 - Gate  
 PIN 3 & CASE - Drain

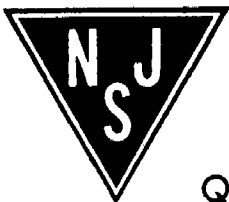
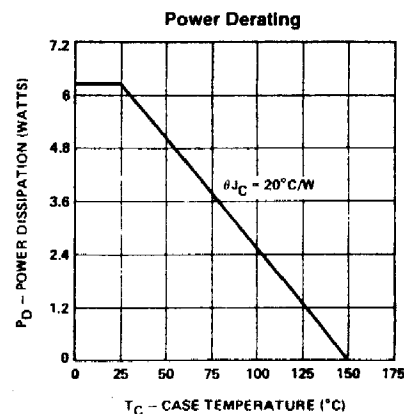
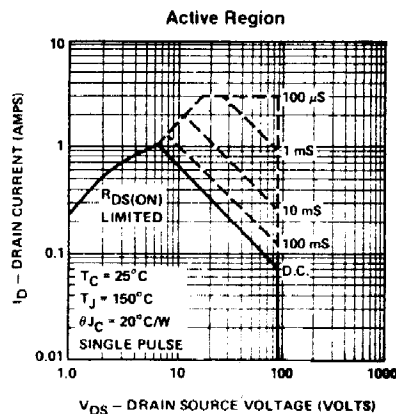


(TO-39)

### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Parameter	2N6661	Units
$V_{DS}$ Drain-Source Voltage	90	V
$V_{DGR}$ Drain-Gate Voltage ( $R_{GS} = 1\text{ M}\Omega$ )	90	V
$I_D @ T_C = 25^\circ\text{C}$ Continuous Drain Current	$\pm 0.9$	A
$I_D @ T_C = 100^\circ\text{C}$ Continuous Drain Current	$\pm 0.7$	A
$I_{DM}$ Pulsed Drain Current <sup>1</sup>	$\pm 3$	A
$V_{GS}$ Gate-Source Voltage	$\pm 40$	V
$P_D @ T_C = 25^\circ\text{C}$ Max. Power Dissipation	6.25	W
$P_D @ T_C = 100^\circ\text{C}$ Max. Power Dissipation	2.5	W
Junction to Case Linear Derating Factor	0.05	W/ $^\circ\text{C}$
Junction to Ambient Linear Derating Factor	0.006	W/ $^\circ\text{C}$
$T_J$ Operating and Storage Temperature Range	-55 To +150	$^\circ\text{C}$
Lead Temperature (1/16" from case for 10 secs.)	300	$^\circ\text{C}$

<sup>1</sup> Pulse Test: Pulswidth  $\leq 300\mu\text{sec}$ , Duty Cycle  $\leq 2\%$



**ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)**  
**STATIC**

Parameter	Type	Min.	Typ.	Max.	Units	Test Conditions
B <sub>V</sub> DSS	Drain-Source Breakdown Voltage	2N6661	90	110		V V <sub>GS</sub> = 0 I <sub>D</sub> = 10 μA
V <sub>GS(th)</sub>	Gate-Threshold Voltage	2N6661	0.8	1.5	2	V V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1 mA
I <sub>GSSF</sub>	Gate-Body Leakage Forward	2N6661		1 5	100 500	nA V <sub>GS</sub> = +15V, V <sub>DS</sub> = 0 V <sub>GS</sub> = +15V, V <sub>DS</sub> = 0, T <sub>A</sub> = 125°C
I <sub>GSSR</sub>	Gate-Body Leakage Reverse	2N6661		-1	-100	nA V <sub>GS</sub> = -15V, V <sub>DS</sub> = 0
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	2N6661		1	10	μA V <sub>DS</sub> = Max. Rating, V <sub>GS</sub> = 0
		2N6661		50	500	μA V <sub>DS</sub> = 0.8 Max. Rating, V <sub>GS</sub> = 0 T <sub>C</sub> = 125°C
I <sub>D(on)</sub>	On-State Drain Current <sup>1</sup>	2N6661	1.5	1.7		A V <sub>DS</sub> ≥ 2V <sub>DS(ON)</sub> , V <sub>GS</sub> = 10V
V <sub>DS(on)</sub>	Static Drain-Source On-State Voltage <sup>1</sup>	2N6661		1.2	1.6	V V <sub>GS</sub> = 5V, I <sub>D</sub> = 0.3A
		2N6661		3	4	V V <sub>GS</sub> = 10V, I <sub>D</sub> = 1A
R <sub>DS(on)</sub>	Static Drain-Source On-State Resistance <sup>1</sup>	2N6661		4	5.3	Ω V <sub>GS</sub> = 5V, I <sub>D</sub> = 0.3A
		2N6661		3	4	Ω V <sub>GS</sub> = 10V, I <sub>D</sub> = 1A
R <sub>DS(on)</sub>	Static Drain-Source On-State Resistance <sup>1</sup>	2N6661		4.1	5.5	Ω V <sub>GS</sub> = 10V, I <sub>D</sub> = 1A, T <sub>C</sub> = 125°C


**DYNAMIC**

g <sub>fs</sub>	Forward Transconductance <sup>1</sup>	2N6661	170	195		mS (mΩ) V <sub>DS</sub> ≥ 2V <sub>DS(ON)</sub> , I <sub>D</sub> = 0.5A
C <sub>iss</sub>	Input Capacitance	2N6661		35	50	pF V <sub>GS</sub> = 0, V <sub>DS</sub> = 25V f = 1 MHz
C <sub>oss</sub>	Output Capacitance	2N6661		33	40	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	2N6661		2	10	pF
t <sub>d(on)</sub>	Turn-On Delay Time	2N6661		8	10	ns V <sub>DD</sub> = 25V, I <sub>D</sub> ≥ 1A R <sub>g</sub> = 25Ω, R <sub>L</sub> = 23Ω (MOSFET switching times are essentially independent of operating temperature.)
t <sub>d(off)</sub>	Turn-Off Delay Time	2N6661		8	10	ns

**THERMAL RESISTANCE**

R <sub>thJC</sub>	Junction-to-Case	2N6661			20	°C/W
R <sub>thJA</sub>	Junction-to-Ambient	2N6661			170	°C/W Free Air Operation

**BODY-DRAIN DIODE RATINGS AND CHARACTERISTICS**

I <sub>S</sub>	Continuous Source Current (Body Diode)	2N6661			-0.9	A	Modified MOSPOWER symbol showing the integral P-N Junction rectifier 
I <sub>SM</sub>	Source Current <sup>1</sup> (Body Diode)	2N6661			-3	A	
V <sub>SD</sub>	Diode Forward Voltage <sup>1</sup>	2N6661		-1.2		V T <sub>C</sub> = 25°C, I <sub>S</sub> = -0.9A, V <sub>GS</sub> = 0	

<sup>1</sup> Pulse Test: Pulse Width < 300 μsec, Duty Cycle < 2%

